



Low EMI, Spread Modulating, Clock Generator

Features:

- ICS91718 is a Spread Spectrum Clock targeted for Mobile PC and LCD panel applications. Generates an EMI optimized clock signal (EMI peak reduction of 7-14 dB on 3rd-19th harmonics) through use of Spread Spectrum techniques.
- ICS91718 operates with input frequencies at 14.318 - 80 MHz.
- Spread modulation frequency range is 20kHz to 40kHz.
- Spread percentage/type programming through I²C.

Specifications:

- Supply Voltages: V_{DD} = 3.3V ±0.3V
- Cyc to Cyc jitter: <150ps
- Output duty cycle 45/55%
- Guarantees +85°C operational condition
- 8-pin SOIC (150 mil) package

Pin Configuration

CLKIN	1	8	PD#*
VDD	2	7	SCLK
GND	3	6	SDATA
CLKOUT/FS_IN0	4	5	REF_OUT/FS_IN1

8-pin SOIC & TSSOP

Notes:

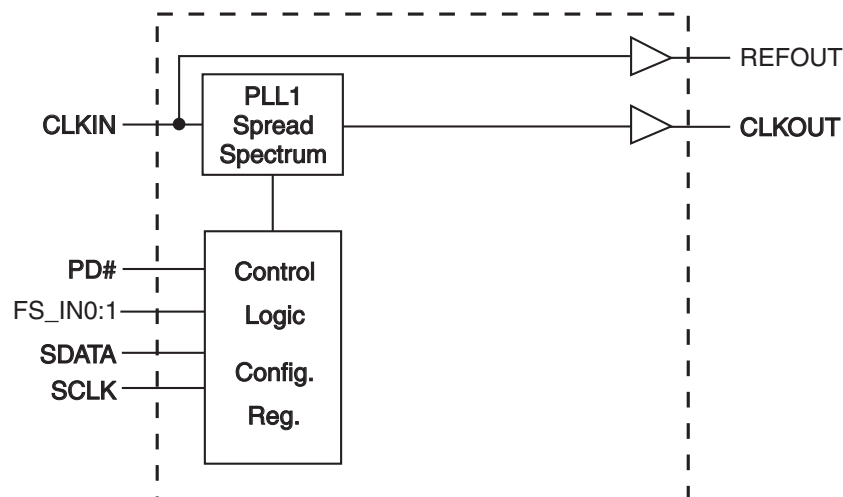
* Internal pull-up resistor

** Internal pull-down resistor

Input Select Functionality

FS_IN1	FS_IN0	MHz	SPREAD %
0	0	14.318 in 48.00 out	-1.0% down sprd
0	1	14.318 in 66.66 out	-1.0% down sprd
1	0	48.00 in/out 66.66 in/out	-1.0% down sprd
1	1	48.00 in/out 66.66 in/out	+/-1.0% center sprd

Block Diagram



Pin Descriptions

PIN #	PIN NAME	PIN TYPE	DESCRIPTION
1	CLKIN	INPUT	Input clock
2	VDD	POWER	Power supply, nominal 3.3V
3	GND	POWER	Ground pin.
4	**CLKOUT/FS_IN0	I/O	CLKOUT modulated clock output FS_IN0 latched input, selects modulation percentage/type
5	REF_OUT/FS_IN1**	I/O	REF_OUT, unmodulated reference clock output FS_IN1 latched input, selects modulation percentage/type
6	SDATA	I/O	Data pin for I2C circuitry 5V tolerant
7	SCLK	INPUT	Clock pin of I2C circuitry 5V tolerant
8	PD#*	INPUT	Asynchronous active low input pin used to power down the device into a low power state. The internal clocks are disabled and the VCO and the crystal are stopped. The latency of the power down will not be greater than 1.8ms.

* Internal Pull-Up Resistor

** Internal Pull-Down Resistor

Table 1: Frequency Configuration Table
(See I2C Byte 0)

	FS4	FS3	FS2	FS1	FS0	Sprd Type	Sprd %
14in/48out	0	0	0	0	0	DOWN SPREAD (-)	0.80
	0	0	0	0	1		1.00
	0	0	0	1	0		1.25
	0	0	0	1	1		1.50
	0	0	1	0	0		1.75
	0	0	1	0	1		2.00
	0	0	1	1	0		2.50
	0	0	1	1	1	CENTER SPREAD (+/-)	0.60
	0	1	0	0	0		1.00
	0	1	0	0	1		1.25
	0	1	0	1	0		1.50
	0	1	0	1	1		2.00
14in/66out	0	1	1	0	0	DOWN SPREAD (-)	1.25
	0	1	1	0	1		1.00
	0	1	1	1	0		1.50
	0	1	1	1	1		2.00
48in/48out 66in/66out	1	0	0	0	0	DOWN SPREAD (-)	0.80
	1	0	0	0	1		1.00
	1	0	0	1	0		1.25
	1	0	0	1	1		1.50
	1	0	1	0	0		1.75
	1	0	1	0	1		2.00
	1	0	1	1	0		2.50
	1	0	1	1	1		3.00
	1	1	0	0	0	CENTER SPREAD (+/-)	0.30
	1	1	0	0	1		0.40
	1	1	0	1	0		0.50
	1	1	0	1	1		0.60
	1	1	1	0	0		0.80
	1	1	1	0	1		1.00
	1	1	1	1	0		1.25
	1	1	1	1	1		1.50

For 14.318 in 48.008 out default is...00001

For 14.318 in 66.66 out default is..01101

For 48/48 and 66/66 default is.....10001

General I²C serial interface information

The information in this section assumes familiarity with I²C programming.
For more information, contact ICS for an I²C programming application note.

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D4_(H)
- ICS clock will **acknowledge**
- Controller (host) sends a dummy command code
- ICS clock will **acknowledge**
- Controller (host) sends a dummy byte count
- ICS clock will **acknowledge**
- Controller (host) starts sending first byte (Byte 0) through byte 6
- ICS clock will **acknowledge** each byte **one at a time**.
- Controller (host) sends a Stop bit

How to Write:	
Controller (Host)	ICS (Slave/Receiver)
Start Bit	
Address D4 _(H)	
	ACK
Dummy Command Code	
	ACK
Dummy Byte Count	
	ACK
Byte 0	
	ACK
Byte 1	
	ACK
Byte 2	
	ACK
Byte 3	
	ACK
Byte 4	
	ACK
Byte 5	
	ACK
Byte 6	
	ACK
Byte 7	
	ACK
Stop Bit	

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the read address D5_(H)
- ICS clock will **acknowledge**
- ICS clock will send the **byte count**
- Controller (host) acknowledges
- ICS clock sends first byte (**Byte 0**) through **byte 7**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a stop bit

How to Read:	
Controller (Host)	ICS (Slave/Receiver)
Start Bit	
Address D5 _(H)	
	ACK
	Byte Count
ACK	
	Byte 0
ACK	
	Byte 1
ACK	
	Byte 2
ACK	
	Byte 3
ACK	
	Byte 4
ACK	
	Byte 5
ACK	
	Byte 6
ACK	
	Byte 7
Stop Bit	

Notes:

1. The ICS clock generator is a slave/receiver, I²C component. It can read back the data stored in the latches for verification. **Read-Back will support Intel PIIX4 "Block-Read" protocol.**
2. The data transfer rate supported by this clock generator is 100K bits/sec or less (standard mode)
3. The input is operating at 3.3V logic levels.
4. The data byte format is 8 bit bytes.
5. To simplify the clock generator I²C interface, the protocol is set to use only "**Block-Writes**" from the controller. The bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. The Command code and Byte count shown above must be sent, but the data is ignored for those two bytes. The data is loaded until a Stop sequence is issued.
6. At power-on, all registers are set to a default condition, as shown.

BYTE	Affected Pin		TYPE	Bit Control		PWD
0	Pin #	Name		0	1	
Bit 7	-	N/A	RW	See ROM TABLE		1
Bit 6	-	N/A	RW			0
Bit 5		N/A	RW			0
Bit 4		N/A	RW			0
Bit 3		N/A	RW			0
Bit 2		N/A	RW	Hi-Z	LOW	1
Bit 1		N/A	RW	OFF	ON	1
Bit 0		HW/SW Control	RW	HW	SW	0

BYTE	Affected Pin		TYPE	Bit Control		PWD
1	Pin #	Name		0	1	
Bit 7	5	REF_OUT	RW	Disable	Enable	1
Bit 6	5	REF_OUT	RW	Nominal	Fast	1
Bit 5		FS_IN1 Readback	RW	-	-	1
Bit 4		FS_IN0 Readback	RW	-	-	1
Bit 3	4	CLK_OUT	RW	Nominal	Fast	1
Bit 2	4	CLK_OUT	RW	Disable	Enable	1
Bit 1		Reserved	R	-	-	1
Bit 0		Reserved	R	-	-	1

BYTE	Affected Pin		TYPE	Bit Control		PWD
2	Pin #	Name		0	1	
Bit 7	x	-	-	-	-	1
Bit 6	x	RESERVED	RW	Disable	Enable	1
Bit 5	x	RESERVED	RW	Disable	Enable	1
Bit 4	x	RESERVED	RW	Disable	Enable	1
Bit 3	x	RESERVED	RW	Disable	Enable	1
Bit 2	x	RESERVED	RW	Disable	Enable	1
Bit 1	x	RESERVED	RW	Disable	Enable	1
Bit 0	x	RESERVED	RW	Disable	Enable	1

BYTE	Affected Pin			TYPE	Bit Control		
3	Pin #	Name	Control Function		0	1	PWD
Bit 7	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 6	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 5	X	RESERVED	RESERVED	RW	Freerun	Not Freerun	1
Bit 4	X	RESERVED	RESERVED	RW	Freerun	Not Freerun	1
Bit 3	x	RESERVED	RESERVED	RW	Freerun	Not Freerun	1
Bit 2	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 1	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 0	X	RESERVED	RESERVED	RW	Disable	Enable	1

BYTE	Affected Pin			TYPE	Bit Control		
4	Pin #	Name	Control Function		0	1	PWD
Bit 7	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 6	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 5	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 4	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 3	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 2	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 1	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 0	X	RESERVED	RESERVED	RW	Disable	Enable	1

BYTE	Affected Pin			TYPE	Bit Control		
5	Pin #	Name	Control Function		0	1	PWD
Bit 7	X	RESERVED	RESERVED	-	-	-	1
Bit 6	X	RESERVED	RESERVED	-	-	-	1
Bit 5	X	RESERVED	RESERVED	-	-	-	1
Bit 4	X	RESERVED	RESERVED	-	-	-	1
Bit 3	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 2	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 1	X	RESERVED	RESERVED	RW	Disable	Enable	1
Bit 0	X	RESERVED	RESERVED	RW	Disable	Enable	1

BYTE	Affected Pin		TYPE	Bit Control		PWD
6	Pin #	Name		0	1	
Bit 7	X	Revision ID Bit 3	(Reserved)	R	-	1
Bit 6	X	Revision ID Bit 2	(Reserved)	R	-	1
Bit 5	X	Revision ID Bit 1	(Reserved)	R	-	1
Bit 4	X	Revision ID Bit 0	(Reserved)	R	-	1
Bit 3	X	Vendor ID Bit 3	(Reserved)	R	-	1
Bit 2	X	Vendor ID Bit 2	(Reserved)	R	-	1
Bit 1	X	Vendor ID Bit 1	(Reserved)	R	-	1
Bit 0	X	Vendor ID Bit 0	(Reserved)	R	-	1

BYTE	Affected Pin		TYPE	Bit Control		PWD
7	Pin #	Name		0	1	
Bit 7	X	DEVICE ID7	(Reserved)	R	-	0
Bit 6	X	DEVICE ID6	(Reserved)	R	-	0
Bit 5	X	DEVICE ID5	(Reserved)	R	-	0
Bit 4	X	DEVICE ID4	(Reserved)	R	-	0
Bit 3	X	DEVICE ID3	(Reserved)	R	-	0
Bit 2	X	DEVICE ID2	(Reserved)	R	-	0
Bit 1	X	DEVICE ID1	(Reserved)	R	-	0
Bit 0	X	DEVICE ID0	(Reserved)	R	-	1

BYTE	Affected Pin		TYPE	Bit Control		PWD
8	Pin #	Name		0	1	
Bit 7	X	Byte Count7	(Reserved)	R	-	0
Bit 6	X	Byte Count6	(Reserved)	R	-	0
Bit 5	X	Byte Count5	(Reserved)	R	-	0
Bit 4	X	Byte Count4	(Reserved)	R	-	0
Bit 3	X	Byte Count3	(Reserved)	R	-	0
Bit 2	X	Byte Count2	(Reserved)	R	-	1
Bit 1	X	Byte Count1	(Reserved)	R	-	1
Bit 0	X	Byte Count0	(Reserved)	R	-	1

Absolute Maximum Ratings

Supply Voltage.....	3.7 V
Voltage on any pin with respect to GND ...	-0.5 to +3.7 V
Storage Temperature	-55°C to +125°C
Operating Temperature	0°C to +85°C
Power Dissipation	0.5 W

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics - Input/Supply/Common Output Parameters

$T_A = 0 - 85^\circ\text{C}$; Supply Voltage $V_{DD} = 3.3 \text{ V} \pm 5\%$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input High Voltage	V_{IH}		2		$V_{DD} + 0.3$	V
Input Low Voltage	V_{IL}		$V_{SS} - 0.3$		0.8	V
Input High Current	I_{IH}	$V_{IN} = V_{DD}$	-5		5	μA
Input Low Current	I_{IL1}	$V_{IN} = 0 \text{ V}$; Inputs with no pull-up resistors	-5			μA
Supply Current	I_{DD}	$f_{IN} = 14.318\text{MHz}$		27	35	mA
		$f_{IN} = 66.66\text{MHz}$		42	50	mA
Powerdown Current	$I_{DD3.3PD}$			3	5	mA
Pin Inductance	L_{pin}				7	nH
Pin Capacitance ¹	C_{IN}	Logic Inputs			5	pF
	C_{OUT}	Output pin capacitance			6	pF
Transition time ¹	T_{trans}	To 1st crossing of target frequency			3	ms
Settling time ¹	T_s	From 1st crossing to 1% target frequency			3	ms
Clk Stabilization ¹	T_{STAB}	From $V_{DD} = 3.3 \text{ V}$ to 1% target frequency		1	3	ms
Delay ¹	t_{PZH}, t_{PZL}	Output enable delay (all outputs)	1		10	ns

¹Guaranteed by design, not 100% tested in production.

AC Electrical Characteristics

$T_A = 0 - 70^\circ\text{C}$; Supply Voltage $V_{DD} = 3.3 \text{ V} \pm 0.3\text{V}$

PARAMETER	DESCRIPTION	TEST CONDITION	MIN	TYP	MAX	UNITS
F_{IN}	Input Frequency	Input Clock	14.318		80	MHz
f_{OUT}	Output Frequency	Spread Off	14.318		80	MHz
t_R	Output Rise Time	15 pF load, 0.8V - 2.4V	0.5		1	ns
t_F	Output Fall Time	15 pF load, 2.4 - 0.8V	0.5		1	ns
I_{OD}	Output Duty Cycle	15 pF load	45		55	%
t_{ID}	Input Duty Cycle		45		55	%
t_{JCyc}	Jitter, Cycle-to-Cycle				250	ps

Electrical Characteristics - CLOCK_OUT

$T_A = 0 - 85^{\circ}\text{C}$; $V_{DD} = 3.3\text{V} \pm 5\%$; $C_L = 10\text{-}20\text{ pF}$ (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Current Source Output Impedance	Z_O^1	$V_O = V_x$	3000			(
Output High Voltage	V_{OH3}	$I_{OH} = -1\text{ mA}$	2.4			V
Output Low Voltage	V_{OL3}	$I_{OL} = 1\text{ mA}$			0.4	
Rise Time	t_{r3}	$V_{OL} = 0.41\text{V}$, $V_{OH} = 0.86\text{V}$	0.5		1	ns
Fall Time	t_{f3}	$V_{OH} = 0.86\text{V}$ $V_{OL} = 0.41\text{V}$	0.5		1	ns
Duty Cycle	d_{t3}	$V_T = 50\%$	45	51	55	%
Jitter, Cycle to cycle	$t_{j\text{cyc-cyc}}^1$	$V_T = 50\%$			250	ps

¹Guaranteed by design, not 100% tested in production.

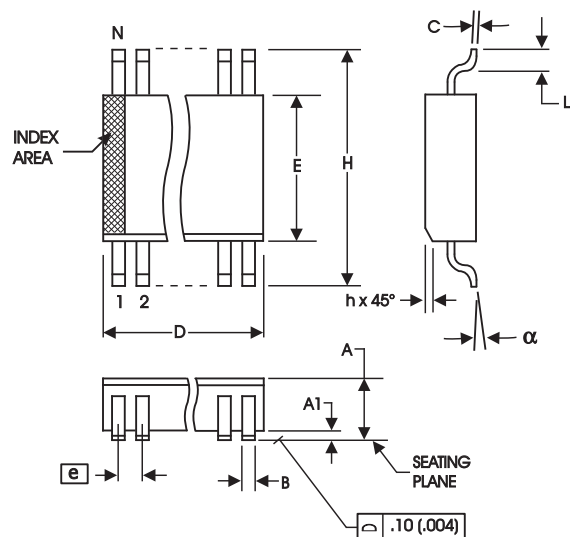
² I_{OWT} can be varied and is selectable thru the MULTSEL pin.

Electrical Characteristics - REF

$T_A = 0 - 85^{\circ}\text{C}$; $V_{DD}=3.3\text{V} \pm 5\%$; $C_L = 10\text{-}20\text{ pF}$ (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Frequency	F_{O1}					MHz
Output Impedance	R_{DSP1}^1	$V_O = V_{DD}*(0.5)$	20		60	\angle
Output High Voltage	V_{OH}^1	$I_{OH} = -1\text{ mA}$	2.4			V
Output Low Voltage	V_{OL}^1	$I_{OL} = 1\text{ mA}$			0.4	V
Output High Current	I_{OH}^1	$V_{OH@MIN} = 1.0\text{ V}$, $V_{OH@MAX} = 3.135\text{ V}$	-29		-23	mA
Output Low Current	I_{OL}^1	$V_{OL@MIN} = 1.95\text{ V}$, $V_{OL@MAX} = 0.4\text{ V}$	29		27	mA
Rise Time	t_{r1}^1	$V_{OL} = 0.4\text{ V}$, $V_{OH} = 2.4\text{ V}$	0.5		1	ns
Fall Time	t_{f1}^1	$V_{OH} = 2.4\text{ V}$, $V_{OL} = 0.4\text{ V}$	0.5		1	ns
Duty Cycle	d_{t1}^1	$V_T = 1.5\text{ V}$	45		55	%
Accumulated Jitter	$t_{j\text{longterm}}$	$V_T = 1.5\text{ V}$ 10us.			2	ns
Jitter	$t_{j\text{cyc-cyc}}^1$	$V_T = 1.5\text{ V}$			500	ps

¹Guaranteed by design, not 100% tested in production.



150mil Body, .50mil pitch

150 mil (Narrow Body) SOIC

SYMBOL	In Millimeters		In Inches	
	COMMON DIMENSIONS		COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	1.35	1.75	.0532	.0688
A1	0.10	0.25	.0040	.0098
B	0.33	0.51	.013	.020
C	0.19	0.25	.0075	.0098
D	SEE VARIATIONS		SEE VARIATIONS	
E	3.80	4.00	.1497	.1574
e	1.27 BASIC		0.050 BASIC	
H	5.80	6.20	.2284	.2440
h	0.25	0.50	.010	.020
L	0.40	1.27	.016	.050
N	SEE VARIATIONS		SEE VARIATIONS	
a	0°	8°	0°	8°

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
8	4.80	5.00	.1890	.1968

Reference Doc.: JEDEC Publication 95, MS-012
10-0030

Ordering Information

ICS91718yMLF-T

Example:

ICS XXXX y M LF- T

Designation for tape and reel packaging

Annealed Lead Free (Optional)

Package Type

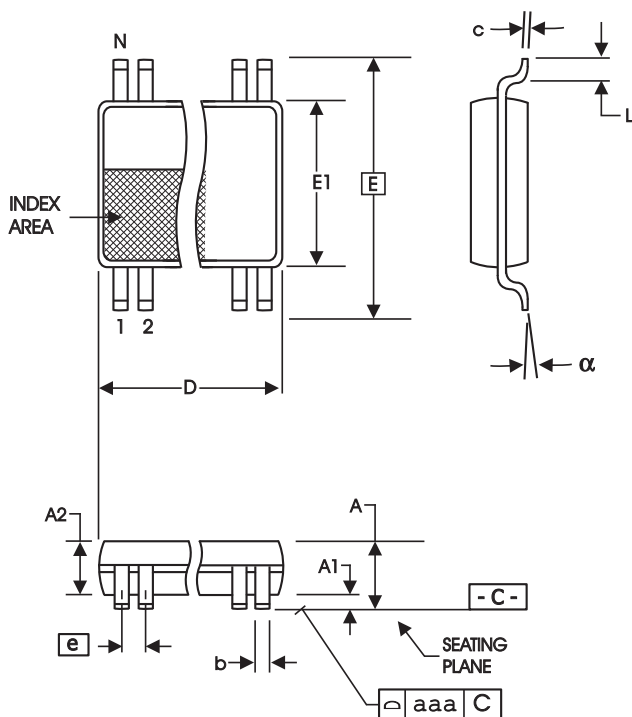
M = SOIC

Revision Designator (will not correlate with datasheet revision)

Device Type

Prefix

ICS = Standard Device



4.40 mm. Body, 0.65 mm. Pitch TSSOP
(173 mil) (25.6 mil)

SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	--	1.20	--	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.19	0.30	.007	.012
c	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
E	6.40 BASIC		0.252 BASIC	
E1	4.30	4.50	.169	.177
e	0.65 BASIC		0.0256 BASIC	
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VARIATIONS	
a	0°	8°	0°	8°
aaa	--	0.10	--	.004

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
8	2.90	3.10	.114	.122

Reference Doc.: JEDEC Publication 95, MO-153

10-0035

Ordering Information

ICS91718yGLF-T

Example:

ICS XXXX y G LF-T

Designation for tape and reel packaging

Annealed Lead Free (Optional)

Package Type

G = TSSOP

Revision Designator (will not correlate with datasheet revision)

Device Type

Prefix

ICS = Standard Device

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